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United States Patent [19]**Deus, III et al.**[11] **Patent Number:** **6,111,819**[45] **Date of Patent:** **Aug. 29, 2000**[54] **REDUCED MECHANICAL COUPLING
INTERLINK FOR SPATIALLY EXTENDED
HYDROPHONES**

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Oliver; Prithvi C. Lall[73] Assignee: **The United States of America as
represented by the Secretary of the
Navy**, Washington, D.C.[57] **ABSTRACT**

An interlink for connecting hydrophone elements that allows a single sensing fiber to transition from a first hydrophone element, across the interlink, to a second hydrophone element, while providing a secure connection between hydrophone elements without the disadvantages of mechanical resonances produced by a rigid interlink material. The interlink has a first end connected to a first hydrophone element, and a second end connected to a second hydrophone element. The interlink may be composed entirely of open cell foam, or a more rigid structure that is covered by open cell foam. Sensing fiber transitions from a first hydrophone element, onto the foam interlink, and thence onto a second hydrophone element, with only a change in winding angle. The sensing fiber is not susceptible to a rigid interlink structure and undesirable mechanical resonances.

[21] Appl. No.: **09/412,197**[22] Filed: **Oct. 4, 1999**[51] Int. Cl.⁷ **H04R 1/44**[52] U.S. Cl. **367/173; 367/154**[58] Field of Search 367/149, 153,
367/154, 173[56] **References Cited****U.S. PATENT DOCUMENTS**

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5 Claims, 2 Drawing Sheets